

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V_{DSS}	-30	V
Gate-Source Voltage		V _{GSS}	±25	V
Continuous Drain Current, V _{GS} = -10V (Note 6)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-8.7 -7.0	А
Continuous Drain Current, V _{GS} = -10V (Note 7)	$T_C = +25$ °C $T_C = +70$ °C	I _D	-30 -25	Α
Maximum Continuous Body Diode Forward Current (Note 7)	Is	-3.6	Α	
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)		I _{DM}	-80	А
Avalanche Current, L = 0.3mH (Note 8)		I _{AS}	-17.5	Α
Avalanche Energy, L = 0.3mH (Note 8)		E _{AS}	64	mJ

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_D	0.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	137	°C/W
Total Power Dissipation (Note 6)		P_{D}	2.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	R _{θJA} 55 °C/W	
Thermal Resistance, Junction to Case (Note 7)		$R_{\theta JC}$	3.5	*C/VV
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C

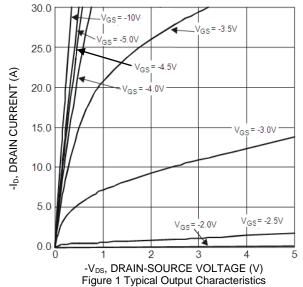
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

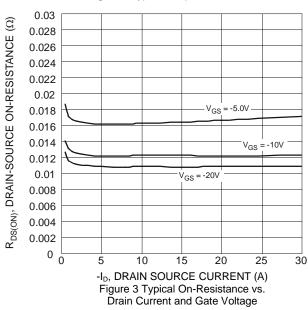
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	-1.0	1	-2.5	٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance		_	_	20	mΩ	$V_{GS} = -10V, I_{D} = -8A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	_	29		$V_{GS} = -5V, I_{D} = -5A$	
Diode Forward Voltage	V_{SD}		-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{iss}	1	1931	1		V _{DS} = -15V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	_	226	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	168	_			
Gate Resistance	R_{G}	_	11	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = -5V)	Qg	_	8.8	_		V _{DS} = -15V, I _D = -10A	
Total Gate Charge (V _{GS} = -10V)	Q_g	_	16.5	_	~C		
Gate-Source Charge	Q _{qs}	_	2.6	_	nC		
Gate-Drain Charge	Q _{gd}	_	3.6	_			
Turn-On Delay Time	t _{D(ON)}	_	8.2	_		$V_{DD} = -15V, V_{GS} = -10V,$ $R_{GEN} = 3\Omega, I_D = -10A$	
Turn-On Rise Time	t _R	_	14	_			
Turn-Off Delay Time	t _{D(OFF)}		65	_	ns		
Turn-Off Fall Time	t _F	_	31.6	_			
Reverse Recovery Time	t _{RR}	_	9.3	_	ns	0.0 41/41 500.0 (
Reverse Recovery Charge	Q _{RR}	_	12.2	_	nC	$I_F = -8A$, di/dt = 500A/ μ s	

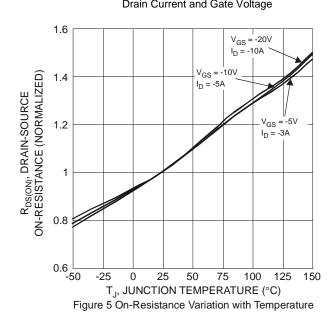
- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



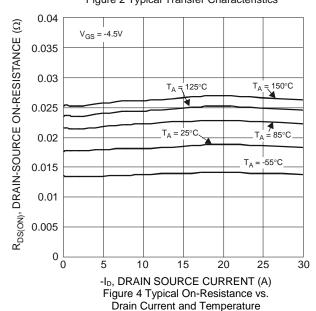


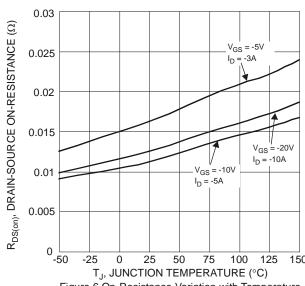






30 $V_{DS} = -5.0V$ 25 -I_D, DRAIN CURRENT (A) 20 15 10 T_A = 150°C T_A = 85°C T_A = 125°C 5 $T_A = 25^{\circ}C$ = -55°C 00 $\hbox{-V}_{\text{GS}}, \, \text{GATE-SOURCE} \, \hbox{VOLTAGE} \, \, (\text{V})$ Figure 2 Typical Transfer Characteristics









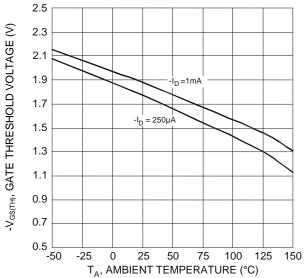


Figure 7 Gate Threshold Variation vs. Ambient Temperature

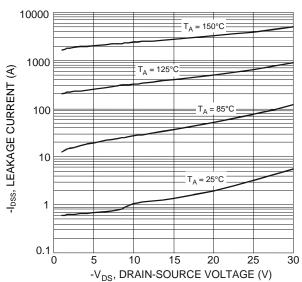
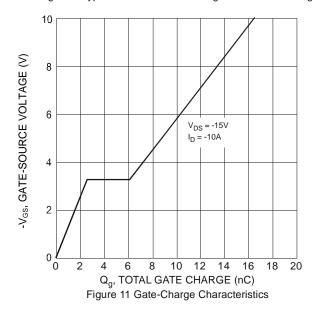
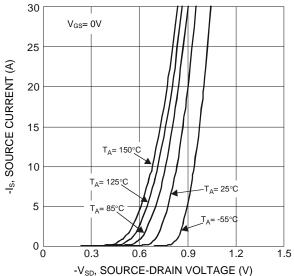
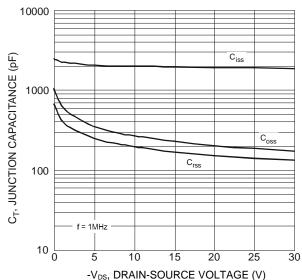


Figure 9 Typical Drain-Source Leakage Current vs. Voltage

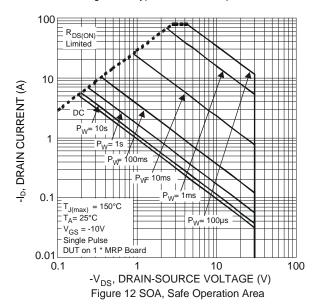




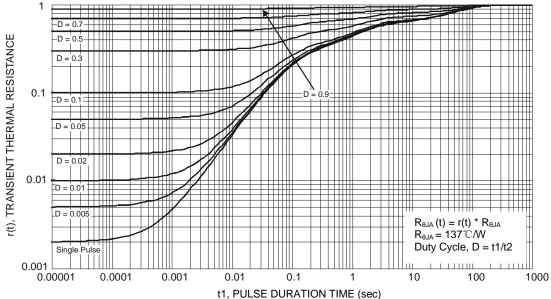
-V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 8 Diode Forward Voltage vs. Current



-V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 10 Typical Junction Capacitance







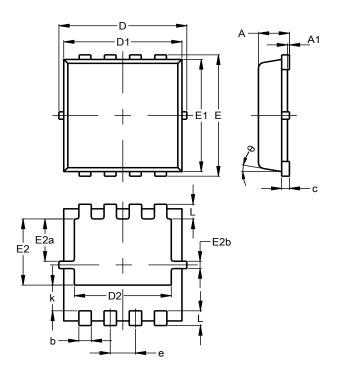
t1, PULSE DURATION TIME (sec) Figure 13 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)

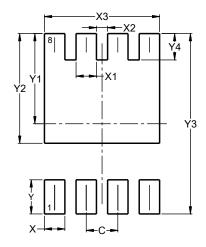


PowerDl3333-8 (Type UX)					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05			
b	0.25	0.40	0.32		
С	0.10	0.25	0.15		
D	3.20	3.40	3.30		
D1	2.95	3.15	3.05		
D2	2.30	2.70	2.50		
Е	3.20	3.40	3.30		
E1	2.95	3.15	3.05		
E2	1.60	2.00	1.80		
E2a	0.95	1.35	1.15		
E2b	0.10	0.30	0.20		
е	0.65 BSC				
k	0.50	0.90	0.70		
L	0.30	0.50	0.40		
θ	0°	12°	10°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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